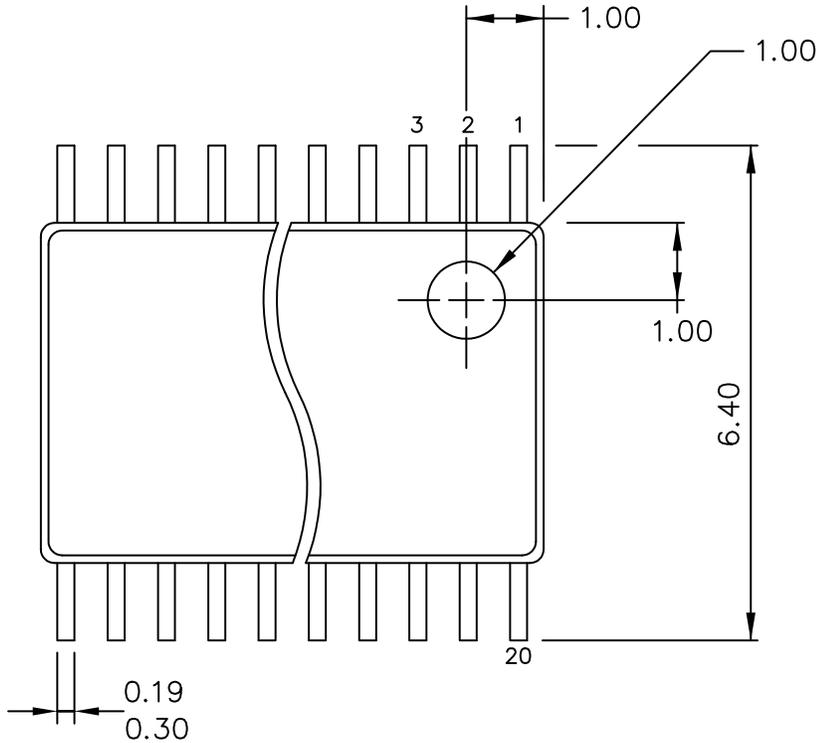


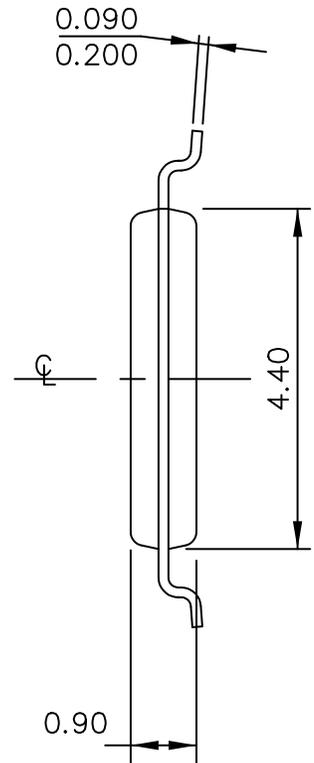
MECHANICAL CASE OUTLINE
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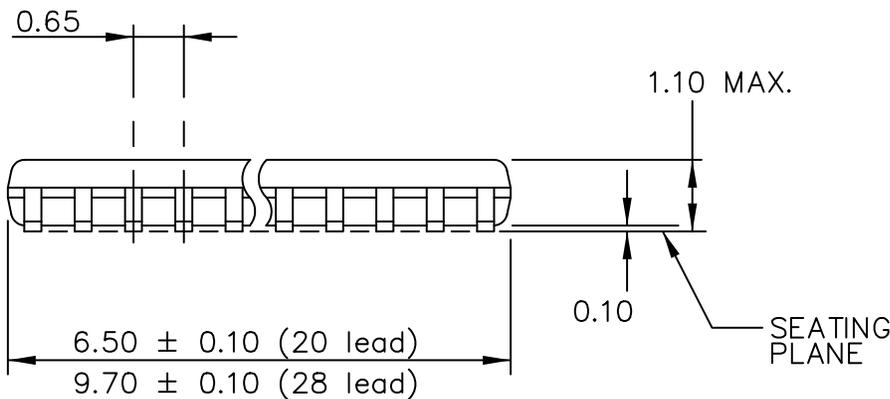
DATE 17 JUL 2008



TOP VIEW



END VIEW



SIDE VIEW

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